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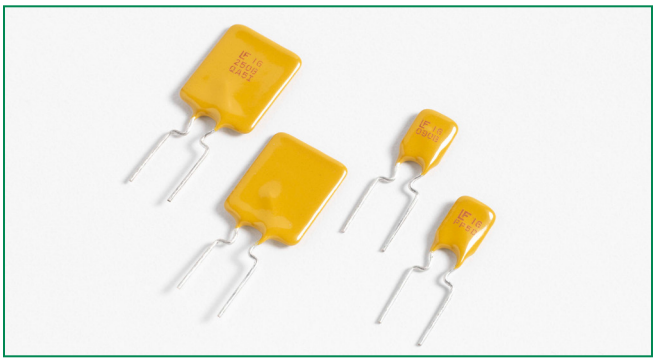
POLY-FUSE® Resettable PTCs

Radial Leaded > 16R Series

16R Series



Description

Littelfuse 16R Series Radial Leaded PTCs are designed to provide resettable overcurrent protection serving a wide range of electronics applications. With maximum 16 volts and maximum 100-ampere short circuit rating, they offer an ideal solution for USB protection.

Features

- 100A short circuit rating
- 16V Operating voltages
- Fast time–to–trip
- Meets all USB protection requirements
- RoHS compliant, Lead-Free and Halogen-Free*

Agency Approvals

AGENCY	AGENCY FILE NUMBER
c UL us	E183209
	R50119318

Applications

- Computers & peripherals
- Any USB application
- General Electronics

Additional Information

Datasheet | Resources | Samples

Electrical Characteristics

Part Number	I_{hold} (A)	I_{trip} (A)	V_{max} (Vdc)	I_{max} (A)	P_d typ. (W)	Maximum Time To Trip		Resistance		Agency Approvals	
						Current (A)	Time (Sec.)	R_{min} (Ω)	R_{1max} (Ω)	c UL us	
16R250G	2.5	4.7	16	100	1.0	12.5	5.0	0.0220	0.0530	X	X
16R300G	3.0	5.1	16	100	2.3	15.0	1.0	0.0380	0.0975	X	X
16R400G	4.0	6.8	16	100	2.4	20.0	1.7	0.0210	0.0600	X	X
16R500G	5.0	8.5	16	100	2.6	25.0	2.0	0.0150	0.0340	X	X
16R600G	6.0	10.2	16	100	2.8	30.0	3.3	0.0100	0.0280	X	X
16R700G	7.0	11.9	16	100	3.0	35.0	3.5	0.0077	0.0200	X	X
16R800G	8.0	13.6	16	100	3.0	40.0	5.0	0.0056	0.0175	X	X
16R900G	9.0	15.3	16	100	3.3	45.0	5.5	0.0047	0.0135	X	X
16R1000G	10.0	17.0	16	100	3.6	50.0	6.0	0.0040	0.0102	X	X
16R1100G	11.0	18.7	16	100	3.7	55.0	7.0	0.0037	0.0089	X	X
16R1200G	12.0	20.4	16	100	4.2	60.0	7.5	0.0033	0.0086	X	X
16R1400G	14.0	23.8	16	100	4.6	70.0	9.0	0.0026	0.0064	X	X

I_{hold} = Hold current: maximum current device will pass without tripping in 20°C still air.
I_{trip} = Trip current: minimum current at which the device will trip in 20°C still air.
V_{max} = Maximum voltage device can withstand without damage at rated current (I_{max})
I_{max} = Maximum fault current device can withstand without damage at rated voltage (V_{max})
P_d = Power dissipated from device when in the tripped state at 20°C still air.
R_{min} = Minimum resistance of device in initial (un-soldered) state.
R_{1max} = Maximum resistance of device at 20°C measured one hour after tripping.
Caution: Operation beyond the specified rating may result in damage and possible arcing and flame.

* Effective January 1, 2010, all 16R PTC products will be manufactured Halogen Free (HF). Existing Non-Halogen Free 16R PTC products may continue to be sold, until supplies are depleted.

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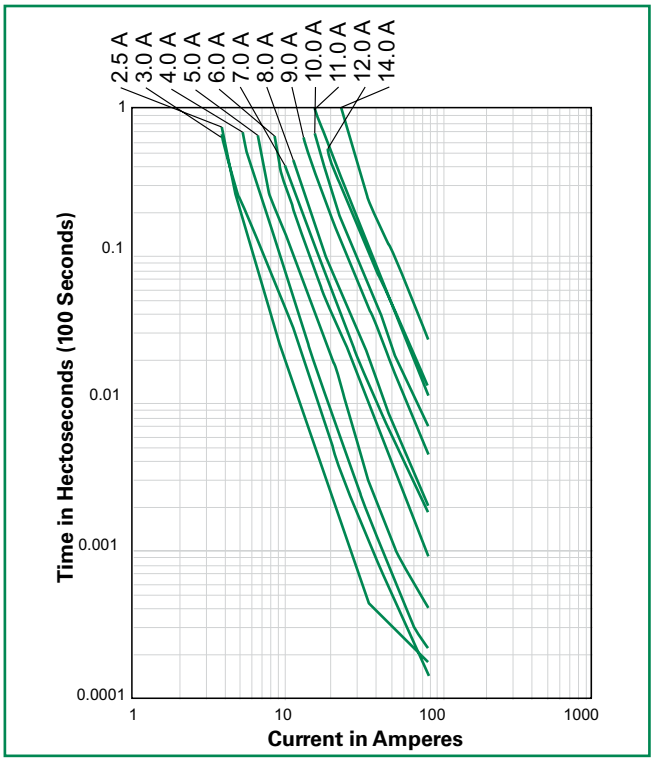
Temperature Rerating

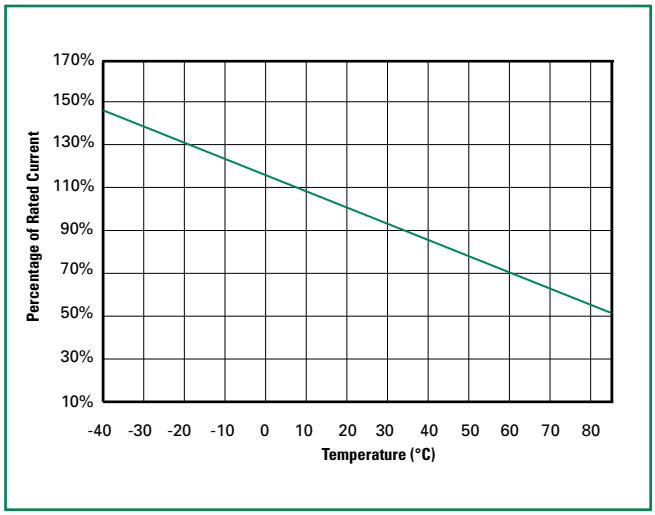
	Ambient Operation Temperature								
	-40°C	-20°C	0°C	20°C	40°C	50°C	60°C	70°C	85°C
Part Number	Hold Current (A)								
16R250G	3.7	3.3	2.9	2.5	2.2	2.0	1.8	1.6	1.3
16R300G	4.4	4.0	3.5	3.0	2.6	2.4	2.1	1.9	1.6
16R400G	5.9	5.3	4.7	4.0	3.5	3.2	2.9	2.6	2.1
16R500G	7.4	6.6	5.9	5.0	4.4	4.0	3.6	3.2	2.6
16R600G	8.9	8.0	7.1	6.0	5.2	4.8	4.3	3.9	3.2
16R700G	10.4	9.3	8.2	7.0	6.1	5.6	5.0	4.5	3.7
16R800G	11.8	10.6	9.4	8.0	7.0	6.3	5.7	5.1	4.2
16R900G	13.3	12.0	10.6	9.0	7.8	7.1	6.5	5.8	4.7
16R1000G	14.8	13.3	11.8	10.0	8.7	7.9	7.1	6.4	5.3
16R1100G	16.3	14.6	12.9	11.0	9.6	8.7	7.9	7.0	5.8
16R1200G	17.7	15.9	14.1	12.0	10.5	9.5	8.6	7.7	6.3
16R1400G	20.7	18.6	16.5	14.0	12.2	11.1	10.0	9.0	7.4

Average Time Current Curves



The average time current curves and Temperature Rerating curve performance is affected by a number or variables, and these curves provided as guidance only. Customer must verify the performance in their application.

Temperature Rerating Curve



Note:
Typical Temperature rerating curve, refer to table for derating data

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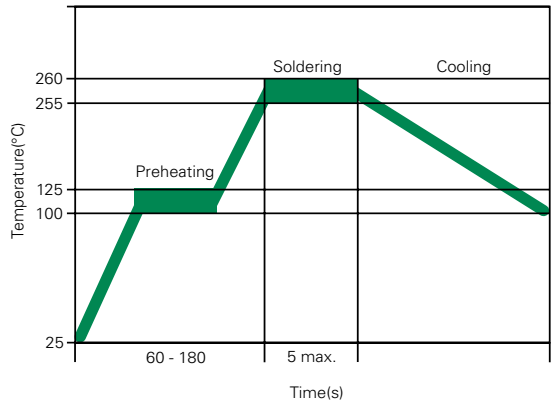
Soldering Parameters - Wave Soldering

Pre-Heating Zone	Refer to the condition recommended by the flux manufacturer. Max. ramping rate should not exceed 4°C/Sec.
Soldering Zone	Max. solder temperature should not exceed 260°C Time within 5°C of actual Max. solder temperature within 3 – 5 seconds Total time from 25°C room to Max. solder temperature within 5 minutes including Pre-Heating time
Cooling Zone	Cooling by natural convection in air. Max. ramping down rate should not exceed 6°C/Sec.



Physical Specifications

Lead Material	2.5A: Tin-plated Copper clad Steel 3.0 - 14.0A: Tin-plated Copper
Soldering Characteristics	Solderability per MIL–STD–202, Method 208
Insulating Material	Cured, flame retardant epoxy polymer meets UL 94V-0 requirements.
Device Labeling	Marked with 'LF', voltage, current rating, and date code.

Environmental Specifications

Operating/Storage Temperature	-40°C to +85°C
Maximum Device Surface Temperature in Tripped State	125°C
Passive Aging	+85°C, 1000 hours -/+ 5% typical resistance change
Humidity Aging	+85°C, 85% R.H., 1000 hours -/+ 5% typical resistance change
Thermal Shock	+85°C to -40°C 10 times -/+ 5% typical resistance change
Solvent Resistance	MIL–STD–202, Method 215 No change
Moisture Resistance Level	Level 1, J–STD–020

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Dimensions

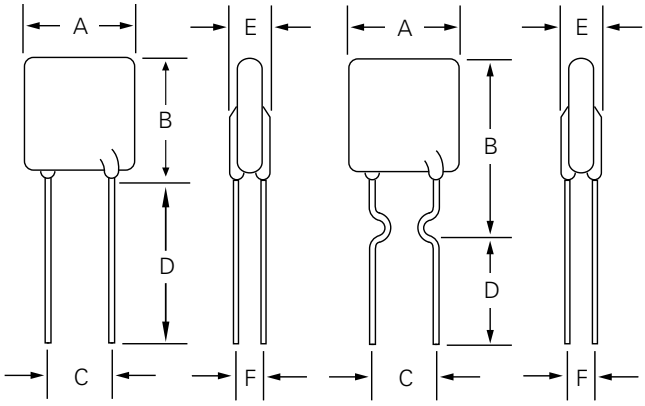
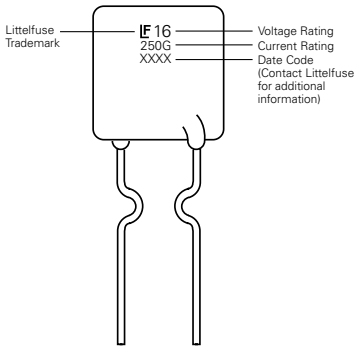


Figure 1

Figure 2

Part Marking System

Single Sided Marking



Part Number	Figure	A		B		C		D		E		F		Physical Characteristics		
		Inches	mm	Inches	mm	Inches	mm	Inches	mm	Inches	mm	Inches	mm	Lead (dia)		Material
		Max.	Max.	Max.	Max.	Typ.	Typ.	Min.	Min.	Max.	Max.	Typ.	Typ.	Inches	mm	
16R250G	2	0.35	8.90	0.50	12.80	0.20	5.1	0.13	3.18	0.12	3.00	0.035	0.9	0.020	0.51	Sn/CuFe
16R300G	1	0.28	7.10	0.43	11.00	0.20	5.1	0.30	7.6	0.12	3.00	0.047	1.2	0.032	0.81	Sn/Cu
16R400G	1	0.35	8.90	0.50	12.80	0.20	5.1	0.30	7.6	0.12	3.00	0.047	1.2	0.032	0.81	Sn/Cu
16R500G	1	0.41	10.40	0.56	14.30	0.20	5.1	0.30	7.6	0.12	3.00	0.047	1.2	0.032	0.81	Sn/Cu
16R600G	1	0.42	10.70	0.67	17.10	0.20	5.1	0.30	7.6	0.12	3.00	0.047	1.2	0.032	0.81	Sn/Cu
16R700G	1	0.44	11.20	0.78	19.70	0.20	5.1	0.30	7.6	0.12	3.00	0.047	1.2	0.032	0.81	Sn/Cu
16R700G KL	2	0.44	11.20	0.93	23.70	0.20	5.1	0.30	7.6	0.12	3.00	0.047	1.2	0.032	0.81	Sn/Cu
16R800G	1	0.50	12.70	0.82	20.90	0.20	5.1	0.30	7.6	0.12	3.00	0.047	1.2	0.032	0.81	Sn/Cu
16R900G	1	0.55	14.00	0.85	21.70	0.20	5.1	0.30	7.6	0.12	3.00	0.047	1.2	0.032	0.81	Sn/Cu
16R1000G	1	0.65	16.50	0.99	25.20	0.20	5.1	0.30	7.6	0.12	3.00	0.047	1.2	0.032	0.81	Sn/Cu
16R1100G	1	0.69	17.50	1.02	26.00	0.20	5.1	0.30	7.6	0.12	3.00	0.047	1.2	0.032	0.81	Sn/Cu
16R1200G	1	0.69	17.50	1.10	28.00	0.40	10.2	0.30	7.6	0.14	3.50	0.055	1.4	0.039	1.00	Sn/Cu
16R1400G	1	0.93	23.50	1.10	27.90	0.40	10.2	0.30	7.6	0.14	3.50	0.055	1.4	0.039	1.00	Sn/Cu

WARNING

- Users shall independently assess the suitability of these devices for each of their applications
- Operation of these devices beyond the stated maximum ratings could result in damage to the devices and lead to electrical arcing and/or fire
- These devices are intended to protect against the effects of temporary over-current or over-temperature conditions and are not intended to perform as protective devices where such conditions are expected to be repetitive or prolonged in duration
- Exposure to silicon-based oils, solvents, electrolytes, acids, and similar materials can adversely affect the performance of these PPTC devices
- These devices undergo thermal expansion under fault conditions, and thus shall be provided with adequate space and be protected against mechanical stresses
- Circuits with inductance may generate a voltage (L di/dt) above the rated voltage of the PPTC device.

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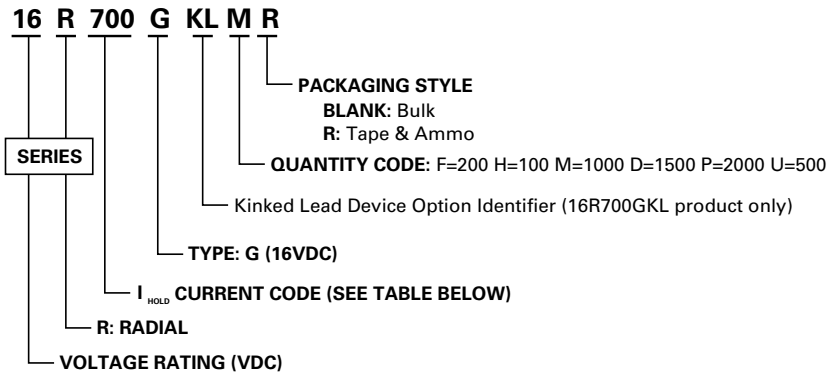
Part Ordering Number System



Packaging Options

Part Number	Ordering Number	I_{hold} (A)	I_{hold} Code	Packaging Option	Quantity	Quantity & Packaging Codes
16R250G	16R250GU	2.50	250	Bulk	500	U
	16R250GPR			Tape and Ammo	2000	PR
16R300G	16R300GU	3.00	300	Bulk	500	U
	16R300GPR			Tape and Ammo	2000	PR
16R400G	16R400GU	4.00	400	Bulk	500	U
	16R400GPR			Tape and Ammo	2000	PR
16R500G	16R500GU	5.00	500	Bulk	500	U
	16R500GPR			Tape and Ammo	2000	PR
16R600G	16R600GU	6.00	600	Bulk	500	U
	16R600GDR			Tape and Ammo	1500	DR
16R700G	16R700GF	7.00	700	Bulk	200	F
	16R700GKLF					
	16R700GMR			Tape and Ammo	1000	MR
	16R700GKLMR					
16R800G	16R800GF	8.00	800	Bulk	200	F
	16R800GMR			Tape and Ammo	1000	MR
16R900G	16R900GF	9.00	900	Bulk	200	F
	16R900GMR			Tape and Ammo	1000	MR
16R1000G	16R1000GF	10.00	1000	Bulk	200	F
	16R1000GMR			Tape and Ammo	1000	MR
16R1100G	16R1100GF	11.00	1100	Bulk	200	F
	16R1100GMR			Tape and Ammo	1000	MR
16R1200G	16R1200GH	12.00	1200	Bulk	100	H
	16R1200GMR			Tape and Ammo	1000	MR
16R1400G	16R1400GH	14.00	1400	Bulk	100	H

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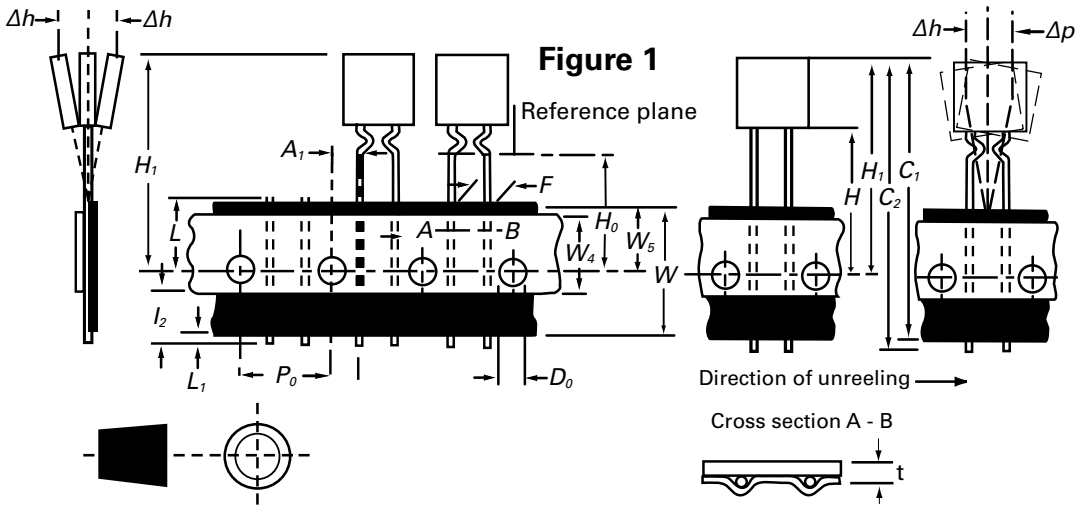
Tape and Ammo Specifications

Devices taped using EIA468-B/IE286-2 standards. See table below and Figure 1 for details.

Dimension	EIA Mark	IEC Mark	Dimensions	
			Dim. (mm)	Tol. (mm)
Carrier tape width	**W**	**W**	18	-0.5 /+1.0
Hold down tape width:	**W_4**	**W_0**	11	min.
Top distance between tape edges	**W_6**	**W_2**	3	max.
Sprocket hole position	**W_5**	**W_1**	9	-0.5 /+0.75
Sprocket hole diameter*	**D_0**	**D_0**	4	-0.32 /+0.2
Abscissa to plane(straight lead)	**H**	**H**	18.5	-/+ 3.0
Abscissa to plane(kinked lead)	**H_0**	**H_0**	16	-/+ 0.5
Abscissa to top			45.0	max.
Overall width w/o lead protrusion			56	max.
Overall width w/ lead protrusion			57	max.
Lead protrusion	**L_1**	**I_1**	1.0	max.
Protrusion of cut out	**L**	**L**	11	max.
Protrusion beyond hold-down tape	**I_2**	**I_2**	Not specified	
Sprocket hole pitch	**P_0**	**P_0**	25.4	-/+ 0.5
Device pitch:			25.4	
Pitch tolerance			20 consecutive.	-/+ 1
Tape thickness	**t**	**t**	0.9	max.
Tape thickness with splice	**t_1**		2.0	max.
Splice sprocket hole alignment			0	-/+ 0.3
Body lateral deviation	**Δh**	**Δh**	0	-/+ 1.0
Body tape plane deviation	**Δp**	**Δp**	0	-/+ 1.3
Ordinate to adjacent component lead*	**P_1**	**P_1**	3.81	-/+ 0.7
Ordinate to adjacent component lead*			7.62	-/+ 0.7
Lead spacing:16R250G-16R1100G	**F**	**F**	5.08	-/+ 0.8
Lead spacing:16R1200G-16R1400G	**F**	**F**	10.18	-/+ 0.8

*Differs from EIA specification

Tape and Ammo Diagram



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